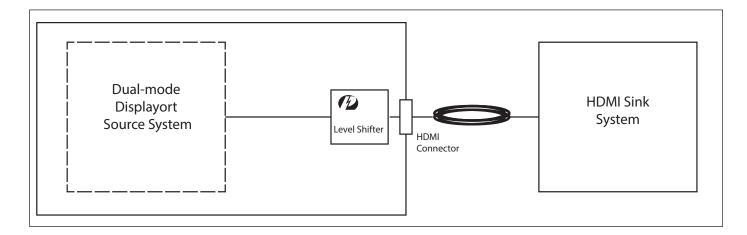
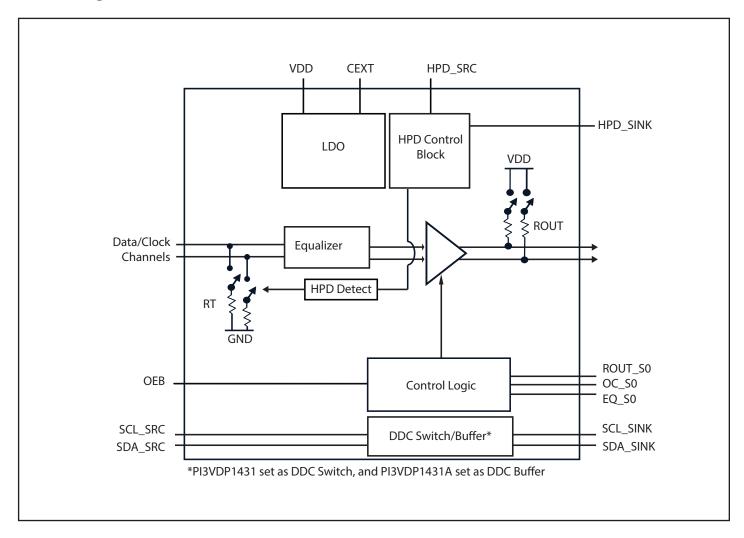


Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

## **Application diagram**



## **Block diagram**



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Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

## **Pin Description**

Pin#	Pin Name	Type	Description
		DILIE	3.3V power supply.
1,22	VDD	PWR	Add external 0.1uF capacitor to GND
_	ODIVE.	DILIE	LDO output for internal core supplier.
2	CEXT	PWR	Add external capacitor (2.2uF-4.7uF) to GND
14,31,32	GND	GND	Ground connection
29	HPD_SINK	I	Sink side hot plug detector input; internal pull-down at 120 Kohm.
11	HPD_SRC	О	HPD output to source side
3	IN_D2-		
4	IN_D2+		
5	IN_D1-		
6	IN_D1+		Th (Do ) PH 500l
7	IN_D0-	I	TMDS inputs. RT=50Ohm
8	IN_D0+		
9	IN_CLK-		
10	In_CLK+		
26	OUT_D2-		
25	OUT_D2+		
24	OUT_D1-		
23	OUT_D1+		TIN CDC DOVITE TOOL
21	OUT_D0-	О	TMDS outputs. ROUT=50Ohm is active when ROUT_S0 = "1"
20	OUT_D0+		
19	OUT_CLK-		
18	OUT_CLK+		
13	SCL_SRC	IO	Source side DDC Clock
12	SDA_SRC	IO	Source side DDC Data
27	SCL_SINK	IO	Sink side DDC Clock for connector
28	SDA_SINK	IO	Sink side DDC Data for connector
16	OC_S0	I	TMDS output three-level pre-emphasis selection. See OC_S0 truth table. GND=0dB, NC=1.5dB, VDD=2.5dB;
17	EQ_S0	I	TMDS input three-level equalization selection. See EQ_S0 truth table. GND=2.5dB, NC=5dB, VDD=7.5dB;
30	OEB	I	Output Enable control. Active low. Internal pull-down at 100 Kohm.
15	ROUT_S0	I	TMDS output double termination selection. Internally pull-up to VDD.



Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

### **Functional Description**

#### **Squelch Function:**

Automatic output squelch function disables TMDS output when no Input signal presents. Output Disable (Squelch) Mode uses TMDS Clock channel signal detection. When low voltage levels on the TMDS input clock signals are detected, Squelch state enables and TMDS output port signals shall disable; when the TMDS clock input signal levels are above a pre-determined threshold voltage, output ports shall return to the normal voltage swing levels.

#### HPD\_SINK Shut Down

When HPD\_SINK pin is floating or tie to GND, TMDS outputs shall shut down to sleep mode; HPD\_SINK does not control DDC channel.

#### Pre-emphasis Control OC\_S0 Truth Table

Output pre-emphasis setting		Functional Description		Notes
ROUT_S0	OC_S0	Single-end Vswing	Pre-emphasis	Notes
	"0"	500 mV	0 dB	Open drain output.
"0"	"NC" or VDD/2	500 mV	1.5 dB	Open drain output: default
	"1"	500 mV	2.5 dB	Open drain output
	"0"	500 mV	0 dB	Double termination
"1"	"NC" or VDD/2	500 mV	1.5 dB	Double termination: default
	"1"	500 mV	2.5 dB	Double termination

#### Input Equalization EQ\_S0Truth Table

EQ_S0	Functional Description	Note
"0"	2.5 dB	
"NC" or VDD/2	5 dB	TMDS Clock(CLK) channel EQ is always fixed as 3dB without pre-emphasis.
"1"	7.5 dB	

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#### **Output Signal Enable OEB Truth Table**

OEB	Functional Description
"0"	Normal mode
"1"	Disable output signal for power saving mode

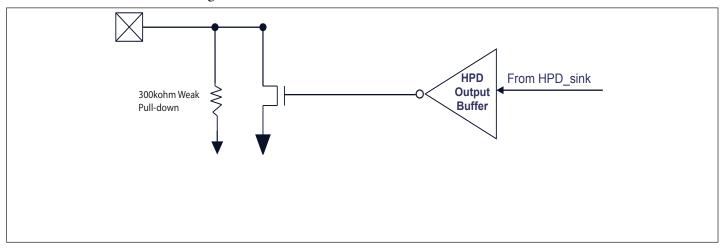




## Sink side Hot Plug Detect HPD\_SINK Truth Table

	HPD_SINK	Functional Description
	"1"	Normal mode
Ī	"0"	Disable output signal for power saving mode

#### Source side HPD\_SRC Block Diagram



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Note:

<sup>\*1:</sup> Open drain buffer is recommended with external pull-up resistor to <4.5V power supply.



Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

### **Absolute Maximum Ratings**

Item	Absolute Rating*1
Supply Voltage to Ground Potential	4.5V
All Inputs and Outputs	-0.5V to 4.5V
5V Tolerance I/O (SDA_SINK,SCL_SINK,HPD_SINK)	-0.5V to 5.5V
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C

Note \*1) Stress beyond those lists under "Absolute Maximum Ratings" may cause permanent damage to the device

## **Recommended Operation Conditions**

Symbol	Parameter	Min.	Тур.	Max.	Unit
TA	Ambient Operating Temperature	-20	25	85	°C
VDD	Power Supply Voltage	2.89	3.3	3.6	V

## **DC Specification** (VDD = $3.3V \pm 10\%$ )

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
IDD	VDD Supply Current	Open drain, 500mV single-end,		80	100	mA
IDD	VDD Supply Current	Pre-emphasis 0dB		80	100	IIIA
ISTB	C4 1 1 1 .	VDD=3.6V, DDC passive switch,		40	50	A
131 b	Stand-by mode	HPD_SINK="0", OEB="1"				uA
ICOLLI	Caualah maada ayamant	VDD=3.6V, DDC passive switch,		2.7	4	A
ISQLH	Squelch mode current	HPD_SINK=3.6V		2.7	4	mA

#### HPD\_SRC pin

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VOL	Open Drain Output Low Voltage	IOL = 4 mA	0		0.4	V
IOFF	Off leakage current	VDD=0, VIN=3.6V			25	
IOZ	Open drain Output leakage current	VDD=3.6, VIN=3.6V			25	μΑ





### HPD\_SINK

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Unit
IIH	High level digital input current(1)	VIH =5.5V	-10		80	μΑ
IIL	Low level digital input current(1)	VIL = GND	-10		10	μA
VIH	High level digital input voltage	VDD=3.3V	2.0			V
VIL	Low level digital input voltage	VDD=3.3V	0		0.8	V

### Control pin (OEB with 100k pull to gnd)

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Unit
IIH	High level digital input current	VIH =3.3V	-10		40	μΑ
IIL	Low level digital input current	VIL = GND	-10		10	μΑ
VIH	High level digital input voltage		2.0			V
VIL	Low level digital input voltage		0		0.8	V

### Control pin (EQ\_S0, OC\_S0 with 100k pull high and 100k pull down when TMDS active)

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Unit
IIH	High level digital input current	VIH =3.3V	-10		40	μΑ
IIL	Low level digital input current	VIL = GND, VDD=3.3V	-40		10	μΑ

### Control pin (ROUT\_S0)

Symbol	Parameter	<b>Test Conditions</b>	Min.	Тур.	Max.	Unit
IIH	High level digital input current	VIH =VDD	-10		10	μΑ
IIL	Low level digital input current	VIL = GND	-20		10	μΑ
VIH	High level digital input voltage		2.0			V
VIL	Low level digital input voltage		0		0.8	V

### DDC Channel switch (P/N: PI3VDP1431)

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Unit
ILK	Input leakage current	DDC switch is OFF, VIN=5.5V	-10		30	μΑ
CIO	Input/Output capacitance when passive switch on	VIpp(peak-peak) = 1V, 100 kHz		10		pF
RON	Passive Switch resistance	IO = 3mA, $VO = 0.4V$		30	50	Ω
VPASS	Switch Output voltage	VI=3.3V, II=100uA, VDD=3.3V	1.5	2.0	2.5	V



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### DDC Channel Buffer (P/N: PI3VDP1431A)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
VIH_SRC	Source Side DDC Buffer Input High Voltage		0.6			V
VIL_SRC	Source Side DDC Buffer Input Low Voltage				0.4	V
VOL_SRC	Source Side DDC Buffer Output Low Voltage	External pull-up to VDD	0.47	0.52	0.6	V
VOL_SINK	Sink Side DDC Buffer Output Low Voltage	from $1.5k\Omega$ to $10k\Omega$			0.2	V
VIH_SINK	Sink Side DDC Buffer Input High Voltage		2.0			V
VIL_SINK	Sink Side DDC Buffer Input Low Voltage				0.8	V
CI_SRC	Source side DDC capacitance when active switch is on, or passive switch off	VIpp(peak-peak)=1V, 100		5		pF
CI_SINK	Sink side DDC capacitance when active switch is on, or passive switch off	KHz		5		pF

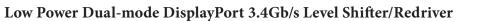
#### TMDS differential pins

Symbol	Parameter	<b>Test Conditions</b>	Min.	Typ.	Max.	Unit
VOH	Single-ended high level output voltage		VDD-10		VDD+10	mV
VOL	Single-ended low level output voltage		VDD-600		VDD- 400	mV
VSWING	Single-ended output swing voltage	VDD 2.2V DOLLT 500	400		600	mV
VOD(O)*1	Overshoot of output differential voltage	$VDD = 3.3V$ , $ROUT=50\Omega$			180 <sup>*1</sup>	mV
VOD(U)*2	Undershoot of output differential voltage				200*2	mV
VOC(SS)	Change in steady-state common- mode output voltage between logic states				5	mV
IOS	Short Circuit output current at open drain mode	Short to VDD	-12		12	mA
103	Short Circuit output current at double termination mode	Short to VDD	-24		24	mA
VI(open)	Single-ended input voltage under high impedance input or open input	II = 10uA	VDD-10		VDD+10	mV
RT	Input termination resistance	VIN = 2.9V	45	50	55	Ω
IOZ	Leakage current with Hi-Z I/O	VDD = 3.6V,			30	μΑ

#### Note:

<sup>\*1)</sup> Overshoot of output differential voltage VOD(O) = (VSWING(MAX) \* 2) \* 15%

<sup>\*2)</sup> Undershoot of output differential voltage VOD(O) = (VSWING(MIN) \* 2) \* 25%





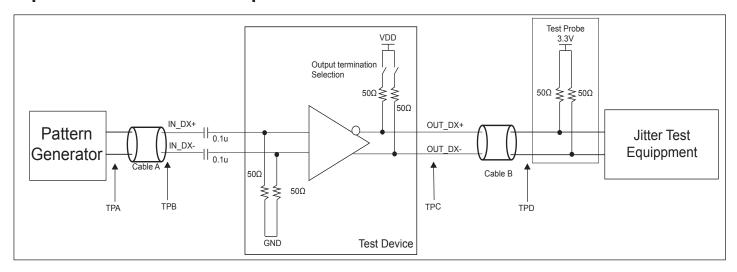
AC Characteristics (Over recommended operating conditions unless otherwise noted)

Symbol	Parameter	<b>Test Condition</b>	Min.	Typ.	Max.	Units
TMDS differe	ential pins	1		·	,	·
tPD	Propagation delay				2000	
tR/tF	Differential output signal rise/fall time(20% - 80%), open drain, 0dB preemphasis			120		
	Differential output signal rise/fall time (20% - 80%), open drain, 2.5dB preemphasis	$VDD = 3.3V$ $ROUT = 50\Omega$		100		
tSK(P)	Pulse skew	-		10	50	ps
tSK(D)	Intra-pair differential skew			23	50	
tSK(O)	Inter-pair differential skew				100	
tJIT(PP)	Peak-to-peak output Clock residual jitter	Data Input = 3.4 Gbps		30 60		
tJIT(PP)	Peak-to-peak output DATA Residual Jitter	HDMI data patterns		40	70	
tEN	Enable time				50	
tDIS	Disable time				0.01	μs
DDC I/O pins	Propagation delay : SCL_SINK/SDA_SINK to SCL/SDA or SCL/ SDA to SCL_SINK/SDA_ SINK in passive SW	CL = 10pF			5	ns
Control and S	status Pins (HPD_SINK, HPD)					
tPD(HPD)	Propagation delay : From HPD_SINK to the active port of HPD, high to low	CL = 10 pF, Pull high resistor= $1k\Omega$ Open drain		10		ns

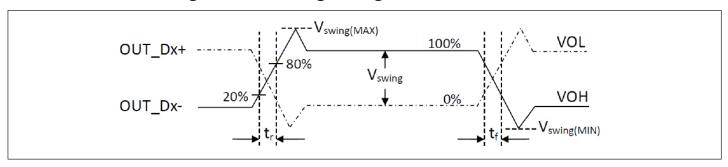


Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

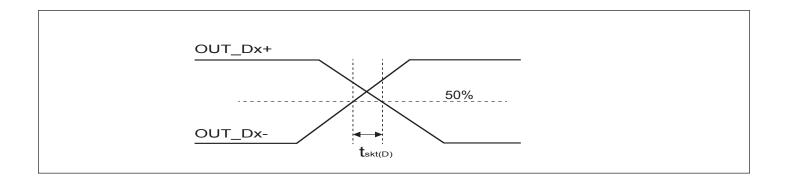
## **Input Measurement Test Setup**



## Rise/Fall Time and Single-ended Swing Voltage



### **Intra-pair Skew Definition**



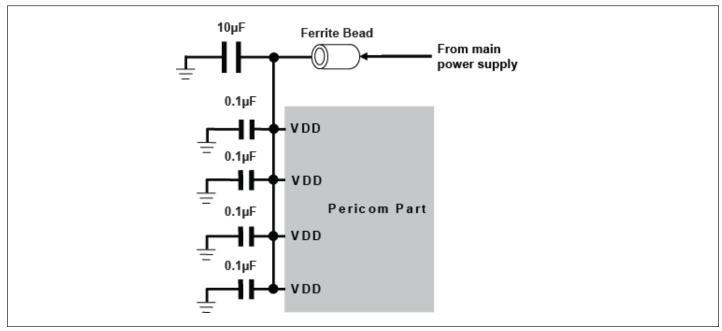
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### **Power Supply Decoupling Circuit**

It is recommended to put  $0.1~\mu F$  decoupling capacitors on each VDD pins of our part, there are four  $0.1~\mu F$  decoupling capacitors are put in Figure 1 with an assumption of only four VDD pins on our part, if there is more or less VDD pins on our Pericm parts, the number of  $0.1~\mu F$  decoupling capacitors should be adjusted according to the actual number of VDD pins. On top of  $0.1~\mu F$  decoupling capacitors on each VDD pins, it is recommended to put a  $10~\mu F$  decoupling capacitor near our part's VDD, it is for stabilizing the power supply for our part. Ferrite bead is also recommended for isolating the power supply for our part and other power supplies in other parts of the circuit. But, it is optional and depends on the power supply conditions of other circuits.



Recommended Power Supply Decoupling Capacitor Diagram

### **De-coupling Capacitors Requirements**

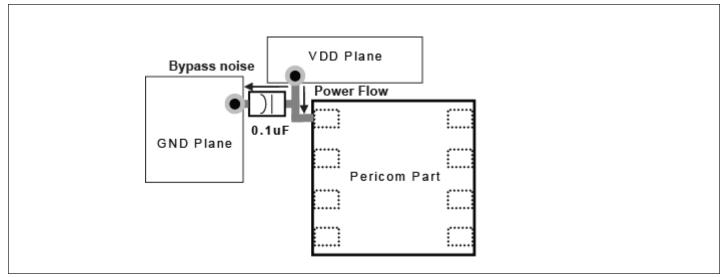
There is no special requirement on the material of the capacitors. Ceramic capacitors are generally being used with typically materials of X5R or X7R.



Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

#### **Layout Placement Consideration**

- → Each 0.1 μF decoupling capacitor should be placed as close as possible to each VDD pin.
- → VDD and GND planes should be used to provide a low impedance path for power and ground.
- → Via holes should be placed to connect to VDD and GND planes directly.
- → Trace should be as wide as possible
- → Trace should be as short as possible.
- → The placement of decoupling capacitor and the way of routing trace should consider the power flowing criteria.
- → 10 µF Capacitor should also be placed closed to our part and should be placed in the middle location of 0.1 µF capacitors.
- → Avoid the large current circuit placed close to our part; especially when it is shared the same VDD and GND planes. Since large current flowing on our VDD or GND planes will generate a potential variation on the VDD or GND of our part.

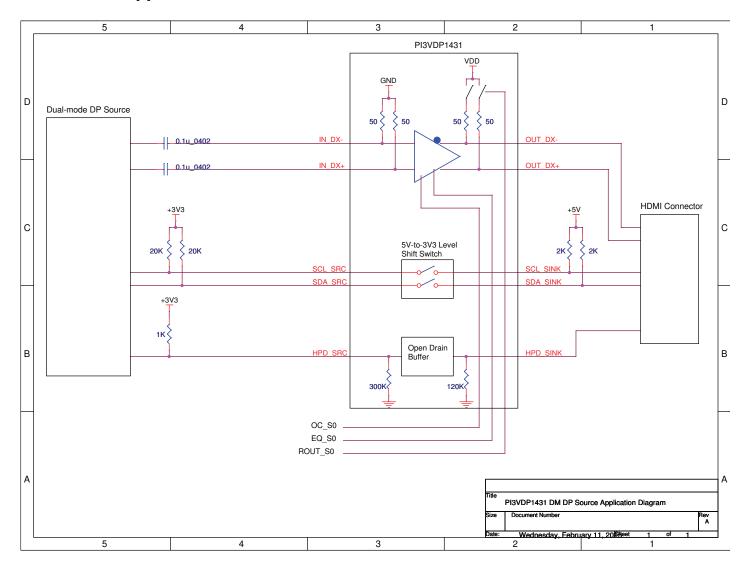


Decoupling Capacitor Placement Diagram





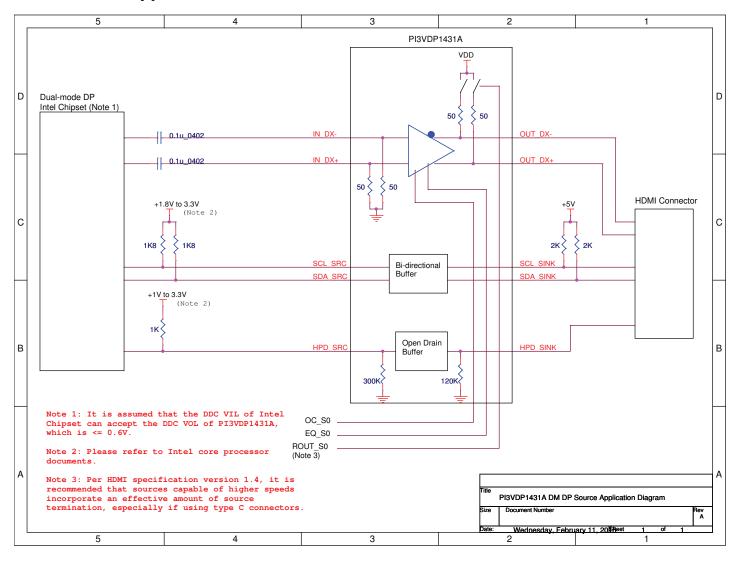
## **PI3VDP1431 Application Schematic**





Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

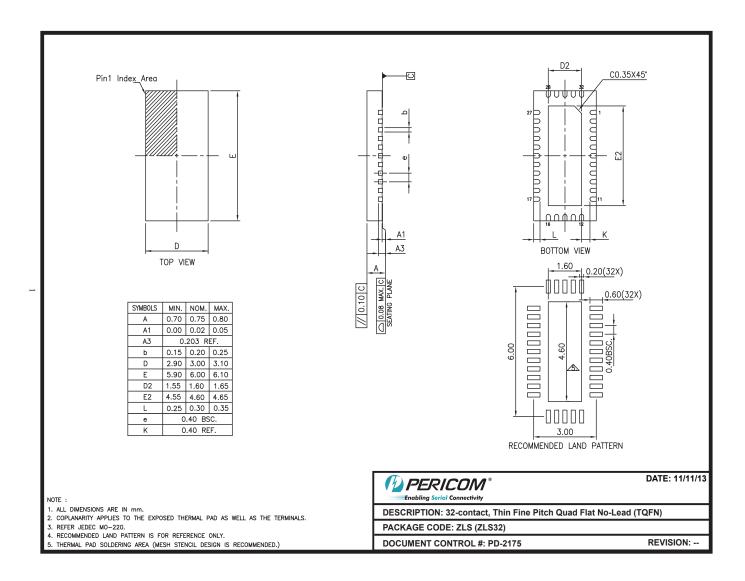
## **PI3VDP1431A Application Schematic**







### Packaging Mechanical: 32-Contact TQFN (ZLS)



 $Please\ check\ for\ the\ latest\ package\ information\ on\ the\ Pericom\ web\ site\ at\ www.pericom.com/support/packaging.$ 

## **Ordering Information**

Ordering Number	Package Code	Package Description
PI3VDP1431ZLSEX	ZLS	32-Contact, Thin Fine Pitch Quad Flat No Lead Package (TQFN) with DDC Switch
PI3VDP1431AZLSEX	ZLS	32-Contact, Thin Fine Pitch Quad Flat No Lead Package (TQFN) with DDC Buffer

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Thermal characteristics can be found on the company web site at www.pericom.com/packaging/

- E = Pb-free and Green
- X suffix = Tape/Reel



Low Power Dual-mode DisplayPort 3.4Gb/s Level Shifter/Redriver

#### **Related Products**

Part Number	Product Description	
PI3WVR12612	Wide Voltage Range DisplayPort™ & HDMI Video Switch	
PI3HDX1204-B	HDMI2.0 Redriver and Displayport Level Shifter for 6Gbps Application	
PI3EQXDP1201	Displayport 1.2 redriver with built-in auto test mode	
PI3HDX414	1:4 Active 3.4Gbps HDMI1.4b Splitter/DeMux with Signal Conditioning	
PI3HDX412BD	1:2 Active 3.4Gbps HDMI1.4b Splitter/DeMux with Signal Conditioning	
PI3HDX621	2:1 Active 3.4Gbps HDMI 1.4b Switch	
PI3HDMI336	3:1 Active 2.5Gbps HDMI Switch with I2C control and ARC Transmitter	

#### **Reference Information**

Document	Description
HDMI1.4b	High-Definition Multimedia Interface Specification Version 1.4b, HDMI Licensing, LLC

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